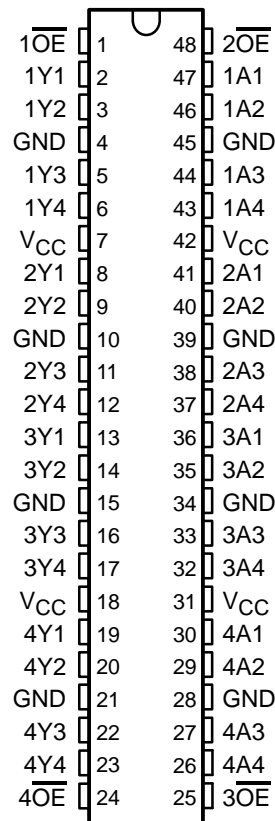


# SN54ALVTH16244, SN74ALVTH16244 2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments **Widebus™** Family
- High-Impedance State During Power Up and Power Down
- 5-V I/O Compatible
- High-Drive Capability (–32 mA/64 mA)
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Auto 3-State Eliminates Bus Current Loading When Voltage at the Output Exceeds  $V_{CC}$
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Power Off Disables Inputs/Outputs, Permitting Live Insertion
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

SN54ALVTH16244 . . . WD PACKAGE  
SN74ALVTH16244 . . . DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



## description

The 'ALVTH16244 are 16-bit buffers/line drivers designed for 2.5-V or 3.3-V  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment. These devices can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When  $V_{CC}$  is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ALVTH16244 is available in TI's thin very small-outline package (DGV), which provides the same I/O pin count and functionality of standard Widebus packages in less than half the printed circuit board area.

The SN54ALVTH16244 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ALVTH16244 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

FUNCTION TABLE  
(each buffer)

INPUTS		OUTPUT
$\overline{OE}$	A	Y
L	H	H
L	L	L
H	X	Z



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

**TEXAS  
INSTRUMENTS**

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PRODUCT PREVIEW

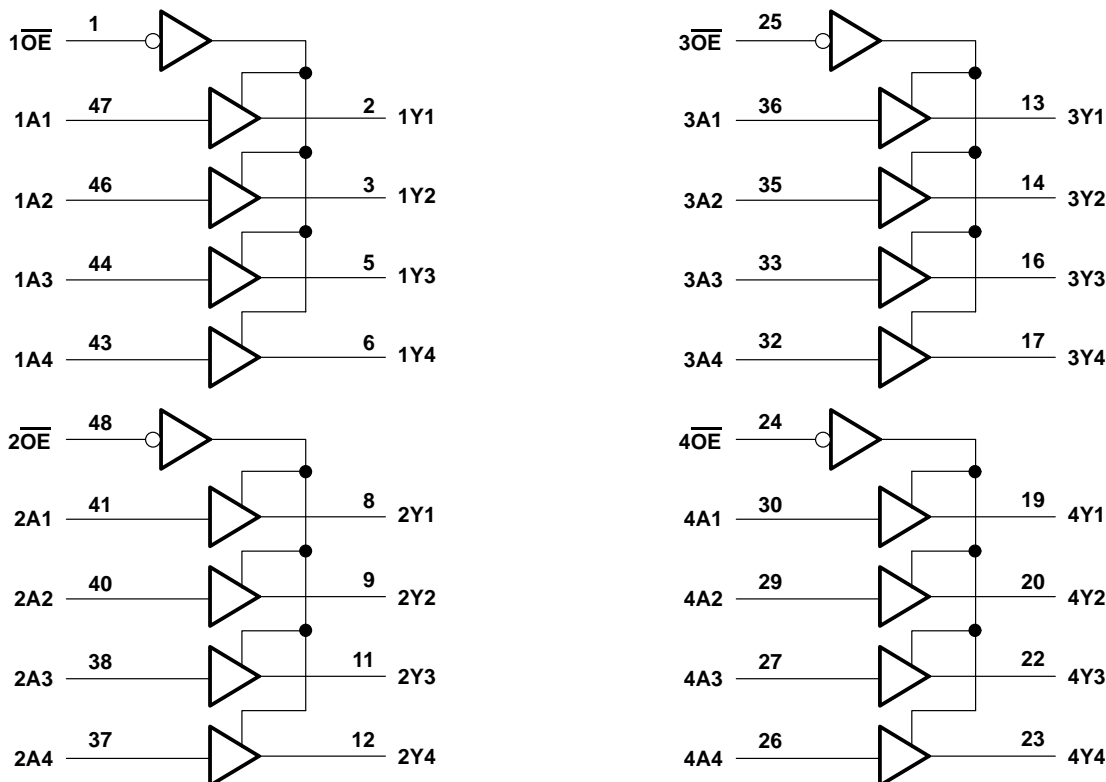
# SN54ALVTH16244, SN74ALVTH16244

## 2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

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#### logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$ (see Note 1)	–0.5 V to 7 V
Output current in the low state, $I_{OL}$ : SN54ALVTH16244	96 mA
SN74ALVTH16244	128 mA
Output current in the high state, $I_{OH}$ : SN54ALVTH16244	–48 mA
SN74ALVTH16244	–64 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	0.85 W
DGV package	0.87 W
DL package	1.2 W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

**SN54ALVTH16244, SN74ALVTH16244**  
**2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**recommended operating conditions,  $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$  (see Note 3)**

			SN54ALVTH16244		SN74ALVTH16244		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		2.3	2.7	2.3	2.7	V
$V_{IH}$	High-level input voltage		1.7		1.7		V
$V_{IL}$	Low-level input voltage			0.7		0.7	V
$V_I$	Input voltage		0	5.5	0	5.5	V
$I_{OH}$	High-level output current			–6		–8	mA
$I_{OL}$	Low-level output current			6		8	mA
	Low-level output current; current duty cycle $\leq 50\%$ ; $f \geq 1\text{ KHz}$			18		24	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$T_A$	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.

**recommended operating conditions,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (see Note 3)**

			SN54ALVTH16244		SN74ALVTH16244		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		3	3.6	3	3.6	V
$V_{IH}$	High-level input voltage		2		2		V
$V_{IL}$	Low-level input voltage			0.8		0.8	V
$V_I$	Input voltage		0	5.5	0	5.5	V
$I_{OH}$	High-level output current			–24		–32	mA
$I_{OL}$	Low-level output current			24		32	mA
	Low-level output current; current duty cycle $\leq 50\%$ ; $f \geq 1\text{ KHz}$			48		64	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$T_A$	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.

**PRODUCT PREVIEW**



**SN54ALVTH16244, SN74ALVTH16244**  
**2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**electrical characteristics over recommended operating free-air temperature range,**  
 **$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$  (unless otherwise noted) (see Figure 1)**

PARAMETER	TEST CONDITIONS		SN54ALVTH16244			SN74ALVTH16244			UNIT	
			MIN	TYP†	MAX	MIN	TYP†	MAX		
V <sub>IK</sub>	V <sub>CC</sub> = 2.3 V, I <sub>I</sub> = −18 mA		−1.2			−1.2			V	
V <sub>OH</sub>	V <sub>CC</sub> = 2.3 V to 2.7 V, I <sub>OH</sub> = −100 μA		V <sub>CC</sub> −0.2			V <sub>CC</sub> −0.2			V	
	V <sub>CC</sub> = 2.3 V	I <sub>OH</sub> = −6 mA	1.7							
		I <sub>OH</sub> = −8 mA				1.7				
V <sub>OL</sub>	V <sub>CC</sub> = 2.3 V to 2.7 V, I <sub>OL</sub> = 100 μA		0.2			0.2			V	
	V <sub>CC</sub> = 2.3 V	I <sub>OL</sub> = 6 mA	0.5							
		I <sub>OL</sub> = 8 mA				0.5				
		I <sub>OL</sub> = 18 mA	0.5							
		I <sub>OL</sub> = 24 mA				0.5				
I <sub>I</sub>	V <sub>CC</sub> = 2.7 V, V <sub>I</sub> = GND		±1			±1			μA	
	V <sub>CC</sub> = 0 or 2.7 V, V <sub>I</sub> = 2.7 V		10			10				
	V <sub>CC</sub> = 2.7 V	V <sub>I</sub> = V <sub>CC</sub>	10			10				
		V <sub>I</sub> = 0	−5			−5				
I <sub>off</sub>	V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V		±100			±100			μA	
I <sub>I(hold)</sub>	V <sub>CC</sub> = 2.3 V	V <sub>I</sub> = 0.7 V	90			90			μA	
		V <sub>I</sub> = 1.7 V	75			75				
	V <sub>CC</sub> = 2.7 V‡, V <sub>I</sub> = 0 to 2.7 V									
I <sub>EX</sub> §	V <sub>CC</sub> = 2.3 V, V <sub>O</sub> = 3.6 V								μA	
I <sub>OZ(PU/PD)</sub> ¶	V <sub>CC</sub> ≤ 1.2 V, V <sub>I</sub> = GND or V <sub>CC</sub> , V <sub>O</sub> = 0.5 V to V <sub>CC</sub> , OE = don't care		±100			±100			μA	
I <sub>OZH</sub>	V <sub>CC</sub> = 2.7 V, V <sub>O</sub> = 2.7 V, V <sub>I</sub> = 0.7 V or 1.7 V		5			5			μA	
I <sub>OZL</sub>	V <sub>CC</sub> = 2.7 V, V <sub>O</sub> = 0 V, V <sub>I</sub> = 0.7 V or 1.7 V		−5			−5			μA	
I <sub>CC</sub>	V <sub>CC</sub> = 2.7 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND		Outputs high		0.04	0.09	0.04		0.09	mA
			Outputs low		2.3	4.5	2.3		4.5	
			Outputs disabled		0.04	0.09	0.04		0.09	
C <sub>i</sub>	V <sub>CC</sub> = 2.5 V, V <sub>I</sub> = 2.5 V or 0		3			3			pF	
C <sub>O</sub>	V <sub>CC</sub> = 2.5 V, V <sub>O</sub> = 2.5 V or 0		9			9			pF	

† All typical values are at  $V_{CC} = 2.5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ Current into an output in the high state when  $V_O > V_{CC}$

¶ High-impedance state during power up/high-impedance state during power down

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**SN54ALVTH16244, SN74ALVTH16244**  
**2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**electrical characteristics over recommended operating free-air temperature range,**  
 **$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 2)**

PARAMETER	TEST CONDITIONS		SN54ALVTH16244			SN74ALVTH16244			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
$V_{IK}$	$V_{CC} = 3\text{ V}$ , $I_I = -18\text{ mA}$				-1.2			-1.2	V
$V_{OH}$	$V_{CC} = 3\text{ V to }3.6\text{ V}$ , $I_{OH} = -100\text{ }\mu\text{A}$		$V_{CC}-0.2$			$V_{CC}-0.2$			V
	$V_{CC} = 3\text{ V}$	$I_{OH} = -24\text{ mA}$	2						
		$I_{OH} = -32\text{ mA}$				2			
$V_{OL}$	$V_{CC} = 3\text{ V to }3.6\text{ V}$ , $I_{OL} = 100\text{ }\mu\text{A}$				0.2			0.2	V
	$V_{CC} = 3\text{ V}$	$I_{OL} = 16\text{ mA}$						0.4	
		$I_{OL} = 24\text{ mA}$			0.5				
		$I_{OL} = 32\text{ mA}$						0.5	
		$I_{OL} = 48\text{ mA}$			0.55				
		$I_{OL} = 64\text{ mA}$						0.55	
$I_I$	$V_{CC} = 3.6\text{ V}$ , $V_I = V_{CC}\text{ or GND}$	Control inputs			$\pm 1$			$\pm 1$	$\mu\text{A}$
	$V_{CC} = 0\text{ or }3.6\text{ V}$ , $V_I = 5.5\text{ V}$				10			10	
	$V_{CC} = 3.6\text{ V}$	$V_I = 5.5\text{ V}$			20			20	
		$V_I = V_{CC}$			10			10	
		$V_I = 0$			-5			-5	
$I_{off}$	$V_{CC} = 0$ , $V_I\text{ or }V_O = 0\text{ to }4.5\text{ V}$				$\pm 100$			$\pm 100$	$\mu\text{A}$
$I_{I(hold)}$	$V_{CC} = 3\text{ V}$	$V_I = 0.8\text{ V}$			75			75	$\mu\text{A}$
		$V_I = 2\text{ V}$			-75			-75	
	$V_{CC} = 3.6\text{ V}^\ddagger$ , $V_I = 0\text{ to }3.6\text{ V}$				$\pm 500$			$\pm 500$	
$I_{EX}^\S$	$V_{CC} = 3\text{ V}$ , $V_O = 5.5\text{ V}$				125			125	$\mu\text{A}$
$I_{OZ(PU/PD)}^\P$	$V_{CC} \leq 1.2\text{ V}$ , $V_I = \text{GND or }V_{CC}$ , $V_O = 0.5\text{ V to }V_{CC}$ , $OE = \text{don't care}$				$\pm 100$			$\pm 100$	$\mu\text{A}$
$I_{OZH}$	$V_{CC} = 3.6\text{ V}$ , $V_O = 3\text{ V}$ , $V_I = 0.8\text{ V or }2\text{ V}$				5			5	$\mu\text{A}$
$I_{OZL}$	$V_{CC} = 3.6\text{ V}$ , $V_O = 0.5\text{ V}$ , $V_I = 0.8\text{ V or }2\text{ V}$				-5			-5	$\mu\text{A}$
$I_{CC}$	$V_{CC} = 3.6\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}\text{ or GND}$	Outputs high		0.07	0.09		0.07	0.09	mA
		Outputs low		3.2	5		3.2	5	
		Outputs disabled		0.07	0.09		0.07	0.09	
$\Delta I_{CC}^\#$	$V_{CC} = 3\text{ V to }3.6\text{ V}$ , One input at $V_{CC} - 0.6\text{ V}$ , Other inputs at $V_{CC}\text{ or GND}$				0.2			0.2	mA
$C_i$	$V_{CC} = 3.3\text{ V}$ , $V_I = 3.3\text{ V or }0$				3			3	pF
$C_o$	$V_{CC} = 3.3\text{ V}$ , $V_O = 3.3\text{ V or }0$				9			9	pF

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ Current into an output in the high state when  $V_O > V_{CC}$

¶ High-impedance state during power up/high-impedance state during power down

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

**PRODUCT PREVIEW**



# SN54ALVTH16244, SN74ALVTH16244 2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$ ,  $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALVTH16244		SN74ALVTH16244			UNIT
			MIN	MAX	MIN	TYP†	MAX	
$t_{pd}$	A	Y	1	3.9	1	2	3.5	ns
$t_{en}$	$\overline{OE}$	Y	2	6.5	2	3.4	5.9	ns
$t_{dis}$	$\overline{OE}$	Y	2	6.2	2	3.5	5.6	ns

† All typical values are at  $V_{CC} = 2.5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$ ,  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (unless otherwise noted) (see Figure 2)

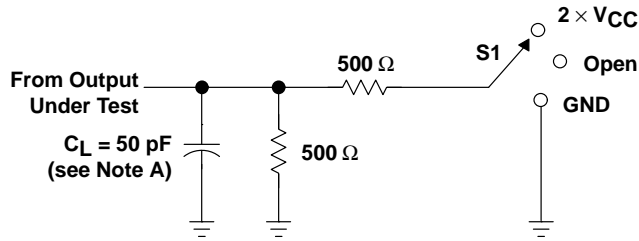
PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALVTH16244		SN74ALVTH16244			UNIT
			MIN	MAX	MIN	TYP‡	MAX	
$t_{pd}$	A	Y	1	2.7	1	1.5	2.4	ns
$t_{en}$	$\overline{OE}$	Y	1.5	4.8	1.5	2.6	4.3	ns
$t_{dis}$	$\overline{OE}$	Y	1.5	4.7	1.5	2.7	4.2	ns

‡ All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

PRODUCT PREVIEW

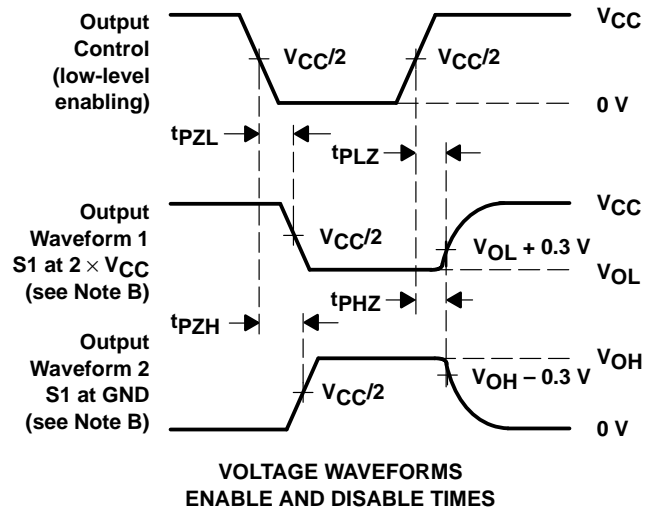
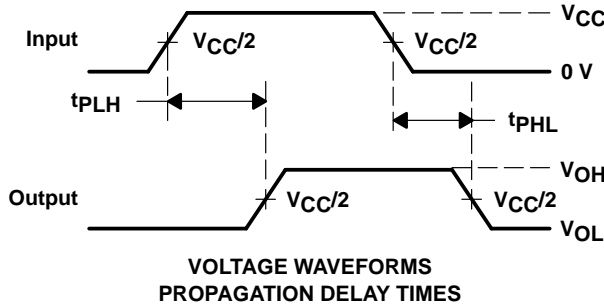
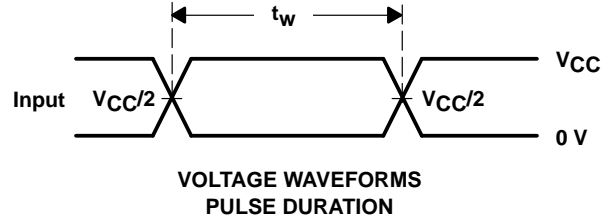
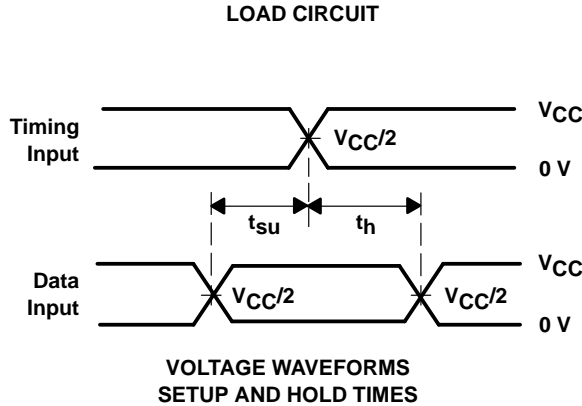
# PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



LOAD CIRCUIT

TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	2 $\times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

# SN54ALVTH16244, SN74ALVTH16244

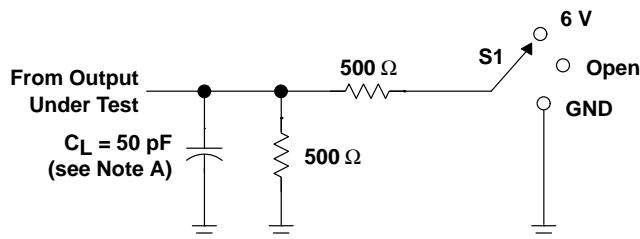
## 2.5-V/3.3-V 16-BIT BUFFERS/DRIVERS

### WITH 3-STATE OUTPUTS

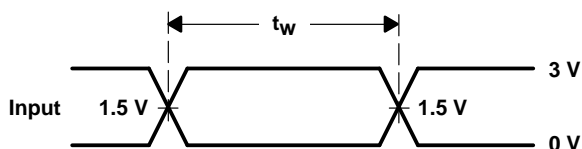
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#### PARAMETER MEASUREMENT INFORMATION

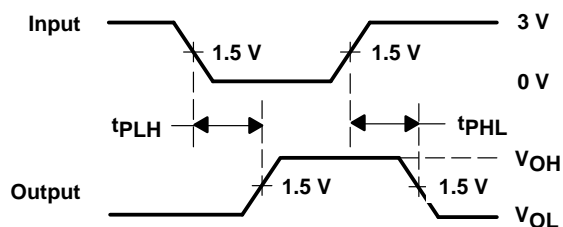
$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$



LOAD CIRCUIT

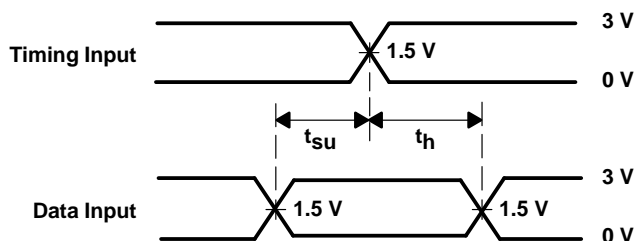


VOLTAGE WAVEFORMS  
PULSE DURATION

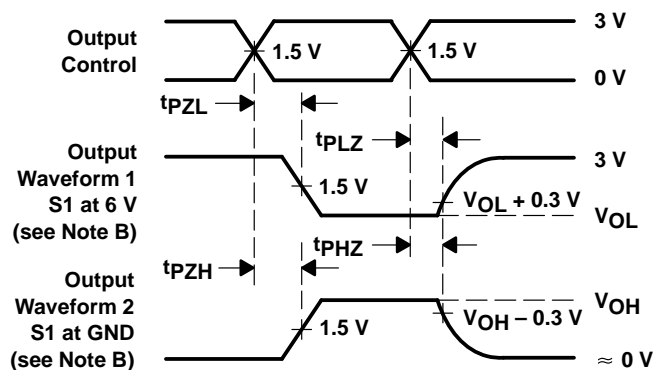


VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS

TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 2. Load Circuit and Voltage Waveforms



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